

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	BRS	L1	18	compliant adj bump	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:09			0
2	IS&R	L2	1	("6028437").PN.	USPAT	2001/08/24 18:05			0
3	BRS	L3	200	compliant and standoff	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:09			0
4	BRS	L4	24	compliant with standoff	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:14			0
5	BRS	L5	47	compliant same standoff	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:15			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
21 BRS	L22	3	test and die and burn and (bump adj aligns)	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 20:30			0
22 BRS	L22	13	test and die and (bump adj aligns)	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 20:30			0
23 IS&R	L23	1	("6028437").PN.	USPAT	2001/08/24 20:30			0
24 IS&R	L24	1	("6229319").PN.	USPAT	2001/08/24 20:30			0

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1 BRS	L1	18	compliant adj bump	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:09			0
2 IS&R	L2	1	("6028437").PN.	USPAT	2001/08/24 18:05			0
3 BRS	L3	200	compliant and standoff	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:09			0
4 BRS	L4	24	compliant with standoff	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:14			0
5 BRS	L5	47	compliant same standoff	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:15			0
6 BRS	L6	0	324/? .cells.	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:21			0
7 BRS	L7	96807	324/S.ccls.	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:25			0
8 BRS	L8	311	L7 and compliant	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:2			0
9 BRS	L9	96807	L7 and compliant	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:2			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
10 BRS	L10	18929	L7 and test	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:22			0
11 BRS	L11	4650	L10 and semiconductor	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 18:23			0
12 BRS	L12	311	L7 and compliant	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 19:02			0
13 IS&R	L13	1	("5815000").PN.	USPAT	2001/08/24 19:42			0
14 BRS	L14	19	Kgd and (bump with aligns)	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 20:00			0
15 BRS	L15	1	Kgd and (bump adj aligns)	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 19:51			0
16 IS&R	L16	1	("5815000").PN.	USPAT	2001/08/24 20:02			0
17 IS&R	L17	1	("6229319").PN.	USPAT	2001/08/24 20:03			0
18 IS&R	L18	0	("test and die and burn and (bump adj aligns)").PN.	USPAT	2001/08/24 20:04			0
19 IS&R	L19	0	("test and die and burn and (bump adj aligns)").PN.	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 20:04			0
20 IS&R	L20	0	("test and die and (bump adj aligns)").PN.	USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM TDB	2001/08/24 20:04			0